



PATENT
Atty. Dkt. No. AMAT/5297/DSM/LOW K/JW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Rivoire, et al.

Serial No.: 09/844,991

Confirmation No.: 1361

Filed: April 27, 2001

**For: METHOD FOR PLANARIZING
ORGANOSILICATE LAYERS**

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Group Art Unit: 3723

Examiner: Robert Rose

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<p>I hereby certify that this correspondence is being deposited on <u>3/26</u>, 2003 with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231.</p>	
<u>3/26/03</u> Date	<u>Kirk E. Parker</u> Signature

PROPOSED DRAWING AMENDMENTS

Applicants propose amending Figure 2b by planarizing the surface of the material of layer “204.”

Applicants submit that no new matter is introduced by these amendments. The proposed correction is shown in red on the attached copy of the drawings.

Applicants respectfully request approval of these drawing amendments.

Respectfully submitted

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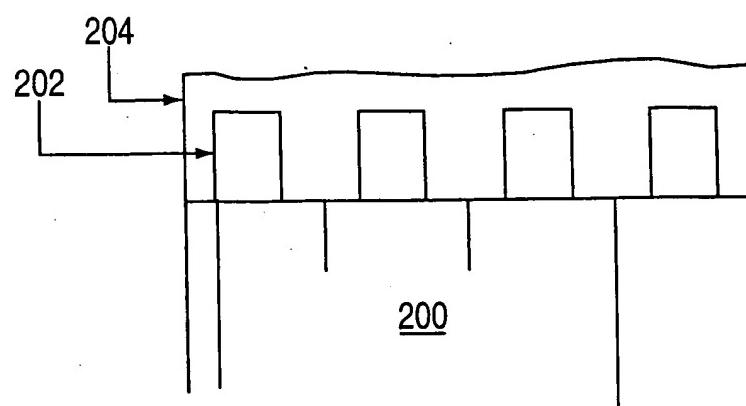


FIG. 2a

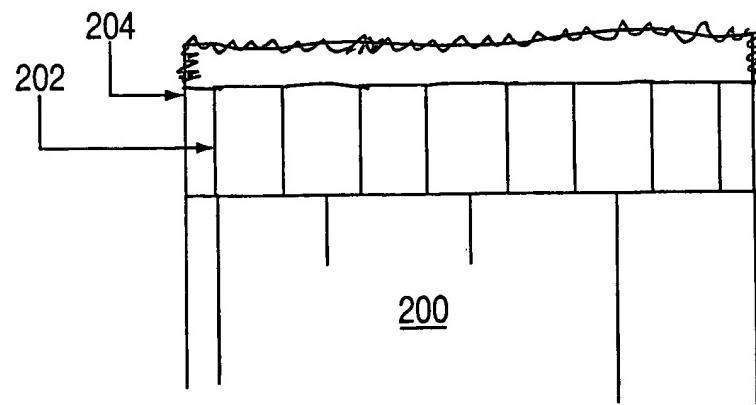


FIG. 2b



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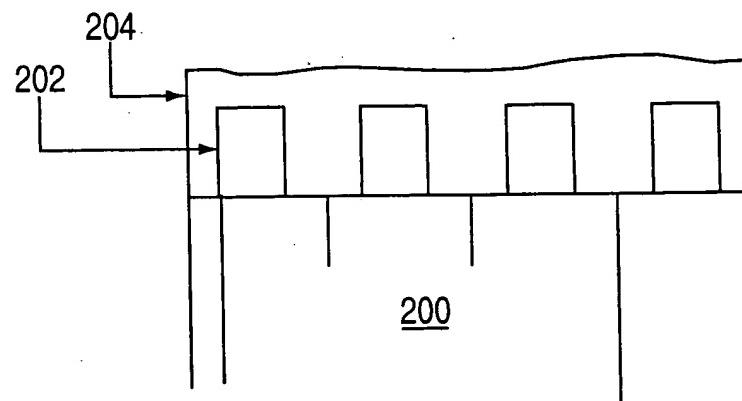


FIG. 2a

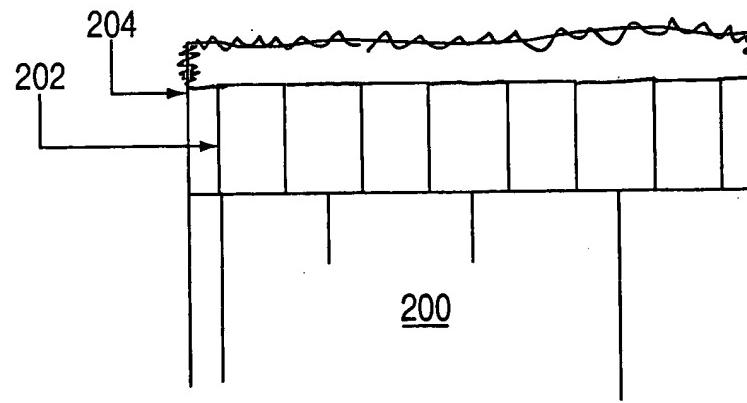


FIG. 2b